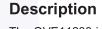


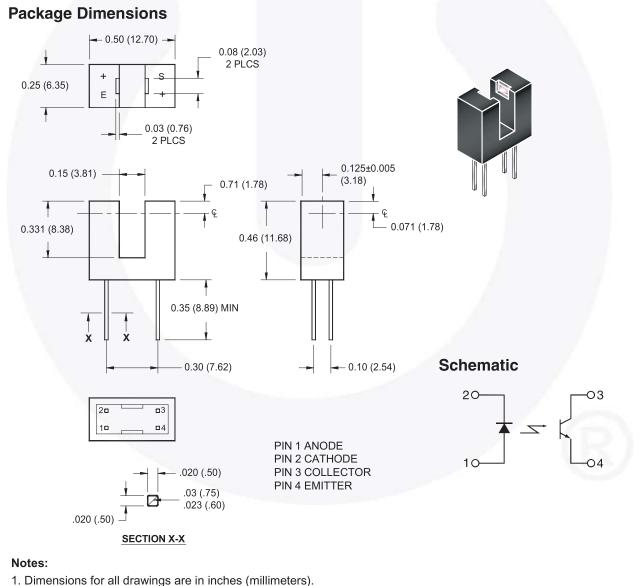
QVE11233 Slotted Optical Switch

Features

- Lead spacing 0.300"
- Gap width of 0.150"
- Printed circuit board mounting
- 2mm aperture width



The QVE11233 is designed to allow the user maximum flexibility in applications. Each switch consists of an infrared emitting diode facing an NPN phototransistor across a 0.150" (3.81mm) gap.



2. Tolerance of ± 0.010 (0.25) on all non-nominal dimensions unless otherwise specified.

Absolute Maximum Ratings (TA = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Rating | Units |
|--------------------|---|----------------|-------|
| T _{OPR} | Operating Temperature | -40 to +85 | °C |
| T _{STG} | Storage Temperature | -40 to +85 | °C |
| T _{SOL-I} | Soldering Temperature (Iron) ⁽²⁾⁽³⁾⁽⁴⁾ | 240 for 5 sec | °C |
| T _{SOL-F} | Soldering Temperature (Flow) ⁽²⁾⁽⁴⁾ | 260 for 10 sec | °C |
| INPUT (EMIT | TER) | | |
| I _F | Continuous Forward Current | 50 | mA |
| V _R | Reverse Voltage | 6 | V |
| PD | Power Dissipation ⁽¹⁾ | 100 | mW |
| OUTPUT (SE | NSOR) | | |
| V _{CEO} | Collector to Emitter Voltage | 30 | V |
| V _{ECO} | Emitter to Collector Voltage | 4.5 | V |
| I _C | Collector Current | 20 | mA |
| P _D | Power Dissipation ⁽¹⁾ | 150 | mW |

Notes:

1. Derate power dissipation linearly, on each component, 1.67mW/°C above 25°C.

2. RMA flux is recommended.

3. Methanol or isopropyl alcohols are recommended as cleaning agents.

4. Soldering iron tip 1/16" (1.6mm) from housing.

Electrical/Optical Characteristics (T_A = 25°C)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|-----------------------|--------------------------------|---|------|------|------|-------|
| INPUT (EMI | TTER) | | | | | |
| V _F | Forward Voltage | I _F = 20mA | | | 1.7 | V |
| I _R | Reverse Leakage Current | V _R = 2V | | | 100 | μA |
| OUTPUT (S | ENSOR) | | - | | | |
| BV _{ECO} | Emitter to Collector Breakdown | I _E = 100μΑ, E _e = 0 | 5.0 | 5 | | V |
| BV _{CEO} | Collector to Emitter Breakdown | $I_{\rm C} = 1 {\rm mA}, {\rm E}_{\rm e} = 0$ | 30 | | 1 | V |
| I _{CEO} | Collector to Emitter Leakage | $V_{CE} = 10V, E_e = 0$ | | | 100 | nA |
| COUPLED | | | 1 | | | |
| I _{C(ON)} | On-State Collector Current | I _F = 20mA, V _{CE} = 5V | 0.5 | | | mA |
| V _{CE (SAT)} | Saturation Voltage | $I_{\rm F} = 20$ mA, $I_{\rm C} = 0.25$ mA | | | 0.40 | V |
| | 1 | I | | | | |

| | | | | U | | |
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